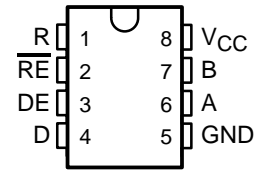- **Integrated Transient Voltage Suppression**
- **ESD Protection for Bus Terminals Exceeds:**
    - **±30 kV IEC 61000-4-2, Contact Discharge**
    - **±15 kV IEC 61000-4-2, Air-Gap Discharge**
    - **±15 kV EIA/JEDEC Human Body Model**
- **Circuit Damage Protection of 400-W Peak (Typical) Per IEC 61000-4-5**
- **Controlled Driver Output-Voltage Slew Rates Allow Longer Cable Stub Lengths**
- **250-kbps in Electrically Noisy Environments**
- **Open-Circuit Fail-Safe Receiver Design**
- **1/4 Unit Load Allows for 128 Devices Connected on Bus**
- **Thermal Shutdown Protection**
- **Power-Up/-Down Glitch Protection**
- **Each Transceiver Meets or Exceeds the Requirements of TIA/EIA-485 (RS-485) and ISO/IEC 8482:1993(E) Standards**
- **Low Disabled Supply Current 300 μA Max**
- **Pin Compatible With SN75176**
- **Applications:**
    - **Industrial Networks**
    - **Utility Meters**
    - **Motor Control**

SN65LBC184D (Marked as 6LB184)
SN75LBC184D (Marked as 7LB184)
SN65LBC184P (Marked as 65LBC184)
SN75LBC184P (Marked as 75LBC184)
(TOP VIEW)

functional logic diagram (positive logic)

description

The SN75LBC184 and SN65LBC184 are differential data line transceivers in the trade-standard footprint of the SN75176 with built-in protection against high-energy noise transients. This feature provides a substantial increase in reliability for better immunity to noise transients coupled to the data cable over most existing devices. Use of these circuits provides a reliable low-cost direct-coupled (with no isolation transformer) data line interface without requiring any external components.

The SN75LBC184 and SN65LBC184 can withstand overvoltage transients of 400-W peak (typical). The conventional combination wave called out in IEC 61000-4-5 simulates the overvoltage transient and models a unidirectional surge caused by overvoltages from switching and secondary lightning transients.
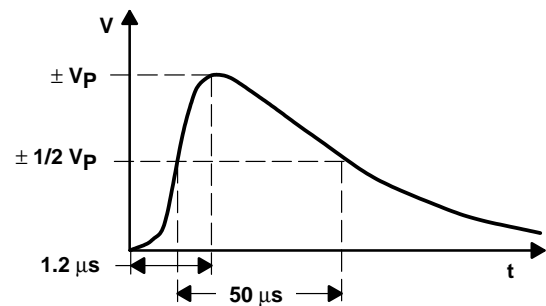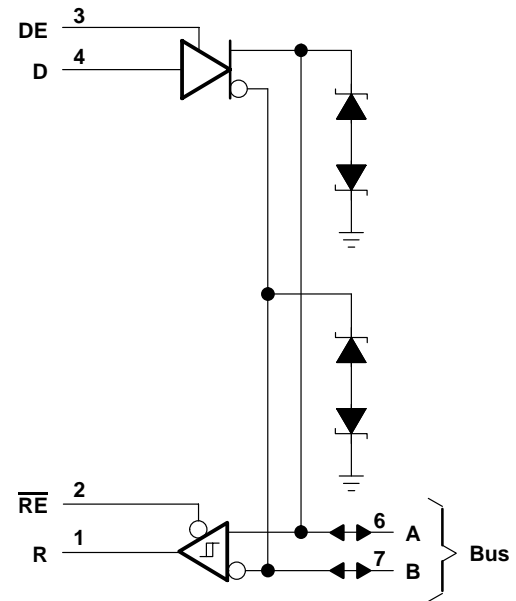

Figure 1. Surge Waveform — Combination Wave

Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

TEXAS INSTRUMENTS

description (continued)

A biexponential function defined by separate rise and fall times for voltage and current simulates the combination wave. The standard 1.2 μs/50 μs combination waveform is shown in Figure 1 and in the test description in Figure 15.

The device also includes additional desirable features for party-line data buses in electrically noisy environment applications including industrial process control. The differential-driver design incorporates slew-rate-controlled outputs sufficient to transmit data up to 250 kbps. Slew-rate control allows longer unterminated cable runs and longer stub lengths from the main backbone than possible with uncontrolled and faster voltage transitions. A unique receiver design provides a fail-safe output of a high level when the inputs are left floating (open circuit). The SN75LBC184 and SN65LBC184 receiver also includes a high input resistance equivalent to one-fourth unit load allowing connection of up to 128 similar devices on the bus.

The SN75LBC184 is characterized for operation from 0°C to 70°C. The SN65LBC184 is characterized from −40°C to 85°C.

schematic of inputs and outputs
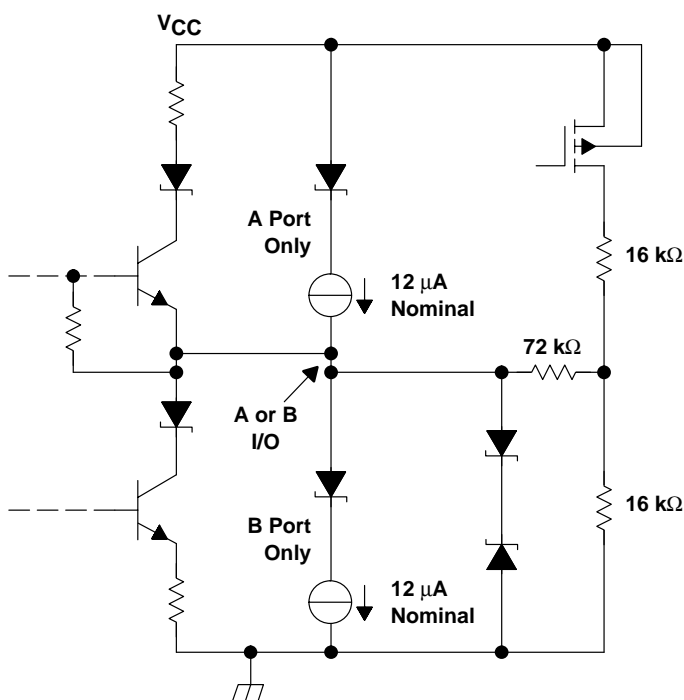
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DRIVER FUNCTION TABLE

INPUT	ENABLE	OUTPUTS	
D	DE	A	B
H	H	H	L
L	H	L	H
X	L	Z	Z

H = high level, L = low level, ? = indeterminate,
X = irrelevant, Z = high impedance (off)

RECEIVER FUNCTION TABLE

DIFFERENTIAL INPUTS	ENABLE	OUTPUT
A – B	$\overline{RE}$	R
$V_{ID} \geq 0.2$ V	L	H
-0.2 V $< V_{ID} < 0.2$ V	L	?
$V_{ID} \leq -0.2$ V	L	L
X	H	Z
Open	L	H

H = high level, L = low level, ? = indeterminate,
X = irrelevant, Z = high impedance (off)

AVAILABLE OPTIONS

	PACKAGE	
T_A	PLASTIC SMALL-OUTLINE[†] (JEDEC MS-012)	PLASTIC DUAL-IN-LINE PACKAGE (JEDEC MS-001)
0°C to 70°C	SN75LBC184D	SN75LBC184P
−40°C to 85°C	SN65LBC184D	SN65LBC184P

[†] Add R suffix for taped and reel.

logic symbol[†]
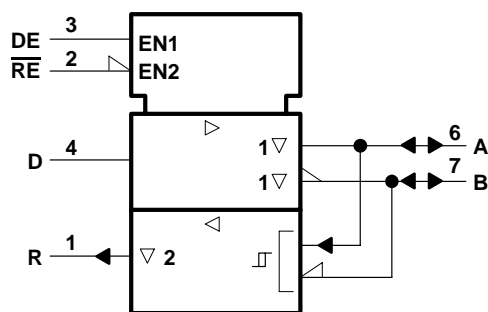
[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

absolute maximum ratings†

Supply voltage, V_{CC} (see Note 1)	−0.5 V to 7 V
Continuous voltage range at any bus terminal	−15 V to 15 V
Data input/output voltage	−0.3 V to 7 V
Electrostatic discharge: Contact discharge (IEC61000-4-2) A, B, GND (see Note 2)	30 kV
Air discharge (IEC61000-4-2) A, B, GND (see Note 2)	15 kV
Human body model (see Note 3) A, B, GND (see Note 2)	15 kV
All pins	3 kV
All terminals (Class 3A) (see Note 2)	8 kV
All terminals (Class 3B) (see Note 2)	1200 V
Continuous total power dissipation (see Note 4)	Internally Limited
Operating free-air temperature range, T_A: SN65LBC184	−40°C to 85°C
SN75LBC184	0°C to 70°C
Storage temperature range, T_{stg}	−65°C to 150°C
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds	260°C

† Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. All voltage values, except differential input/output bus voltage, are with respect to network ground terminal.
2. GND and bus terminal ESD protection is beyond readily available test equipment capabilities for IEC 61000-4-2, EIA/JEDEC test method A114-A and MIL-STD-883C method 3015. Ratings listed are limits of test equipment; device performance exceeds these limits.
3. Tested in accordance with JEDEC Standard 22, Test Method A114-A.
4. The driver shuts down at a junction temperature of approximately 160°C. To operate below this temperature, see the Dissipation Rating Table.

DISSIPATION RATING TABLE

PACKAGE	$T_A \leq 25°C$ POWER RATING	DERATING FACTOR ABOVE $T_A = 25°C$	$T_A = 70°C$ POWER RATING	$T_A = 85°C$ POWER RATING
D	725 mW	5.8 mW/°C	464 mW	377 mW
P	1150 mW	9.2 mW/°C	736 mW	598 mW

recommended operating conditions

		MIN‡	TYP	MAX	UNIT
Supply voltage, V_{CC}		4.75	5	5.25	V
Voltage at any bus terminal (separately or common mode), V_I or V_{IC}		−7		12	V
High-level input voltage, V_{IH}	D, DE, and $\overline{RE}$	2			V
Low-level input voltage, V_{IL}	D, DE, and $\overline{RE}$			0.8	V
Differential input voltage, $|V_{ID}|$				12	V
High-level output current, I_{OH}	Driver	−60			mA
	Receiver	−8			mA
Low-level output current, I_{OL}	Driver			60	mA
	Receiver			4	
Operating free-air temperature, T_A	SN75LBC184	0		70	°C
	SN65LBC184	−40		85	°C

‡ The algebraic convention, in which the less-positive (more-negative) limit is designated minimum, is used in this data sheet.

DRIVER SECTION

electrical characteristics over recommended operating conditions (unless otherwise noted)

PARAMETER		ALTERNATE SYMBOLS	TEST CONDITIONS	MIN	TYP†	MAX	UNIT
I_{CC}	Supply current	NA	DE = $\overline{RE}$ = 5 V, No Load		12	25	mA
			DE = 0 V, $\overline{RE}$ = 5 V, No Load		175	300	µA
I_{IH}	High-level input current (D, DE, $\overline{RE}$)	NA	V_I = 2.4 V			50	µA
I_{IL}	Low-level input current (D, DE, $\overline{RE}$)	NA	V_I = 0.4 V	−50			µA
I_{OS}	Short-circuit output current (see Note 5)	NA	V_O = −7 V	−250	−120		mA
			V_O = V_{CC}			250	
			V_O = 12 V			250	
I_{OZ}	High-impedance output current	NA			See Receiver I_I		mA
V_O	Output voltage	V_{oa}, V_{ob}	I_O = 0	0		V_{CC}	V
$V_{OC(PP)}$	Peak-to-peak change in common-mode output voltage during state transitions	NA	See Figures 5 and 6		0.8		V
V_{OC}	Common-mode output voltage	$|V_{os}|$	See Figure 4	1		3	V
$|\Delta V_{OC(SS)}|$	Magnitude of change, common-mode steady-state output voltage	$|V_{os} - \overline{V}_{os}|$	See Figure 5			0.1	V
$|V_{OD}|$	Magnitude of differential output voltage $|V_A - V_B|$	V_o	I_O = 0	1.5		6	V
			R_L = 54 Ω, See Figure 4	1.5			V
$\Delta|V_{OD}|$	Change in differential voltage magnitude between logic states	$||V_t| - |\overline{V}_t||$	R_L = 54 Ω			0.1	V

† All typical values are measured with T_A = 25°C and V_{CC} = 5 V.
NOTE 5: This parameter is measured with only one output being driven at a time.

switching characteristics over recommended operating conditions (unless otherwise noted)

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
$t_{d(DH)}$	Differential output delay time, low-to-high-level output				1.3	µs
$t_{d(DL)}$	Differential-output delay time, high-to-low-level output				1.3	µs
t_{PLH}	Propagation delay time, low-to-high-level output	R_L = 54 Ω, C_L = 50 pF, See Figure 5		0.5	1.3	µs
t_{PHL}	Propagation delay time, high-to-low-level output			0.5	1.3	µs
$t_{sk(p)}$	Pulse skew $(|t_{d(DH)} - t_{d(DL)}|)$			75	150	ns
t_r	Rise time, single ended		0.25		1.2	µs
t_f	Fall time, single ended		0.25		1.2	µs
t_{PZH}	Output enable time to high level	R_L = 110 Ω, See Figure 2			3.5	µs
t_{PZL}	Output enable time to low level	R_L = 110 Ω, See Figure 3			3.5	µs
t_{PHZ}	Output disable time from high level	R_L = 110 Ω, See Figure 2			2	µs
t_{PLZ}	Output disable time from low level	R_L = 110 Ω, See Figure 3			2	µs

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RECEIVER SECTION

electrical characteristics over recommended operating conditions (unless otherwise noted)

PARAMETER		TEST CONDITIONS		MIN	TYP†	MAX	UNIT
I_{CC}	Supply current (total package)	DE = $\overline{RE}$ = 0 V,	No Load			3.9	mA
		$\overline{RE}$ = 5 V, No Load	DE = 0 V,			300	μA
I_I	Input current	Other input = 0 V	V_I = 12 V			250	μA
			V_I = 12 V, V_{CC} = 0			250	
			V_I = −7 V	−200			
			V_I = −7 V, V_{CC} = 0	−200			
I_{OZ}	High-impedance-state output current	V_O = 0.4 V to 2.4 V				±100	μA
V_{hys}	Input hysteresis voltage				70		mV
V_{IT+}	Positive-going input threshold voltage					200	mV
$V_{IT−}$	Negative-going input threshold voltage			−200			mV
V_{OH}	High-level output voltage	I_{OH} = −8 mA	Figure 7	2.8			V
V_{OL}	Low-level output voltage	I_{OL} = 4 mA	Figure 7			0.4	V

† All typical values are at V_{CC} = 5 V, T_A = 25°C.

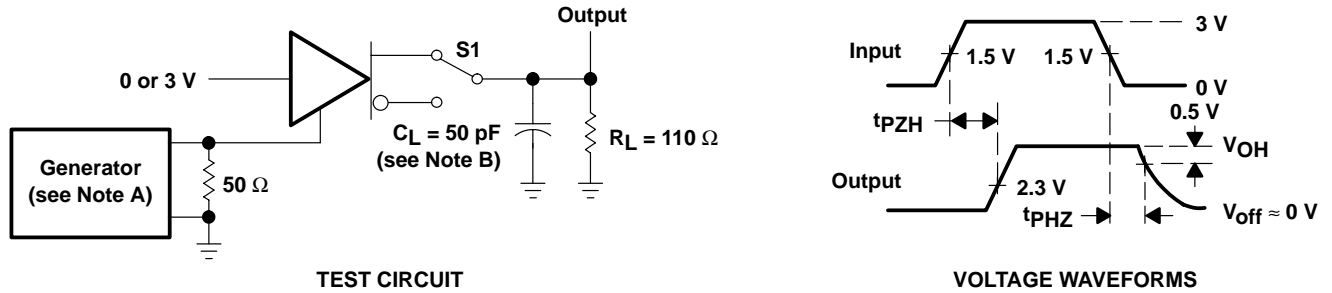### switching characteristics over recommended operating conditions (unless otherwise noted)

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
t_{PLH}	Propagation delay time, low-to-high-level output	C_L = 50 pF, See Figure 7			150	ns
t_{PHL}	Propagation delay time, high-to-low-level output				150	ns
$t_{sk(p)}$	Pulse skew ($|t_{pHL} − t_{pLH}|$)				50	ns
t_r	Rise time, single ended	See Figure 7			20	ns
t_f	Fall time, single ended				20	ns
t_{PZH}	Output enable time to high level	See Figure 8			100	ns
t_{PZL}	Output enable time to low level				100	ns
t_{PHZ}	Output disable time from high level				100	ns
t_{PLZ}	Output disable time from low level				100	ns

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PARAMETER MEASUREMENT INFORMATION
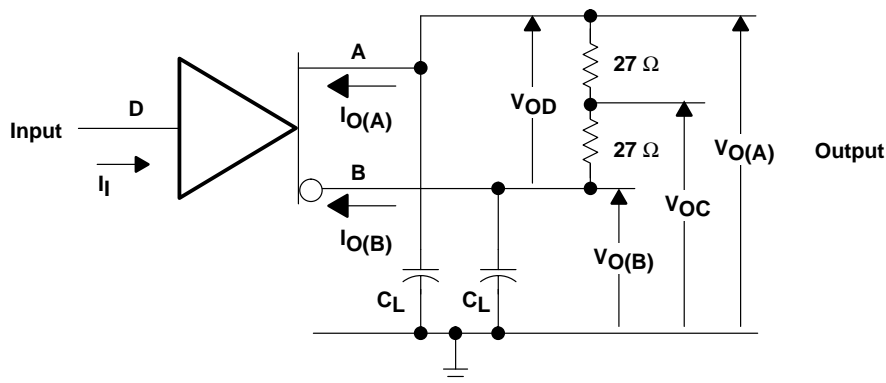

TEST CIRCUIT   **VOLTAGE WAVEFORMS**

NOTES: A. The input pulse is supplied by a generator having the following characteristics: PRR = 1.25 kHz, 50% duty cycle, $t_r \leq 10$ ns, $t_f \leq 10$ ns, $Z_O = 50 \ \Omega$.
B. C_L includes probe and jig capacitance.

Figure 2. Driver t_{PZH} and t_{PHZ} Test Circuit and Voltage Waveforms

TEST CIRCUIT   **VOLTAGE WAVEFORMS**

NOTES: A. The input pulse is supplied by a generator having the following characteristics: PRR = 1.25 kHz, 50% duty cycle, $t_r \leq 10$ ns, $t_f \leq 10$ ns, $Z_O = 50 \ \Omega$.
B. C_L includes probe and jig capacitance.

Figure 3. Driver t_{PZL} and t_{PLZ} Test Circuit and Voltage Waveforms

NOTES: A. Resistance values are in ohms and are 1% tolerance.
B. C_L includes probe and jig capacitance.

Figure 4. Driver Test Circuit, Voltage, and Current Definitions
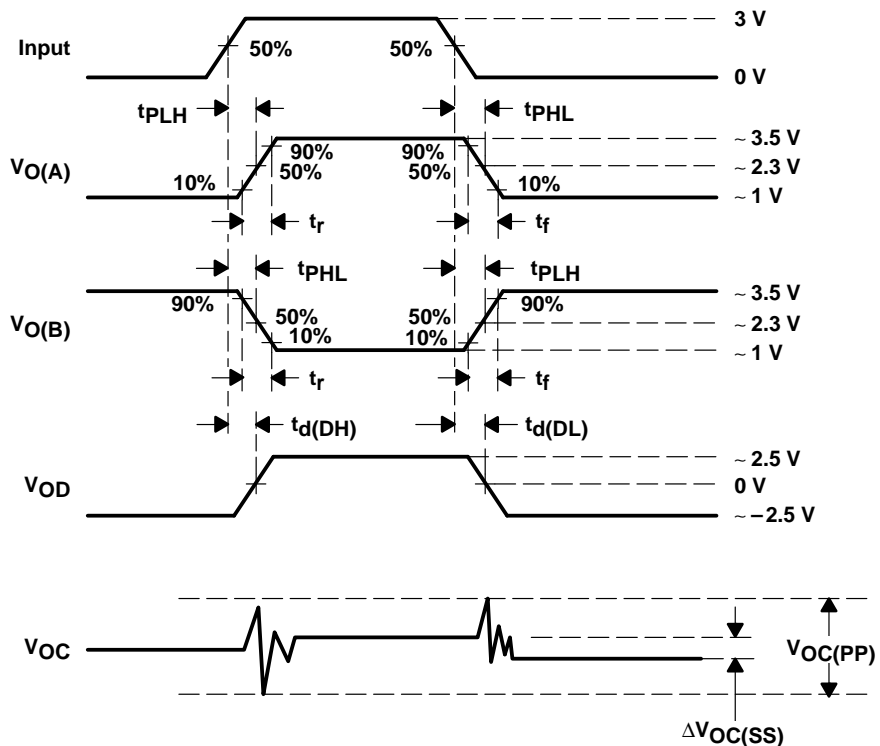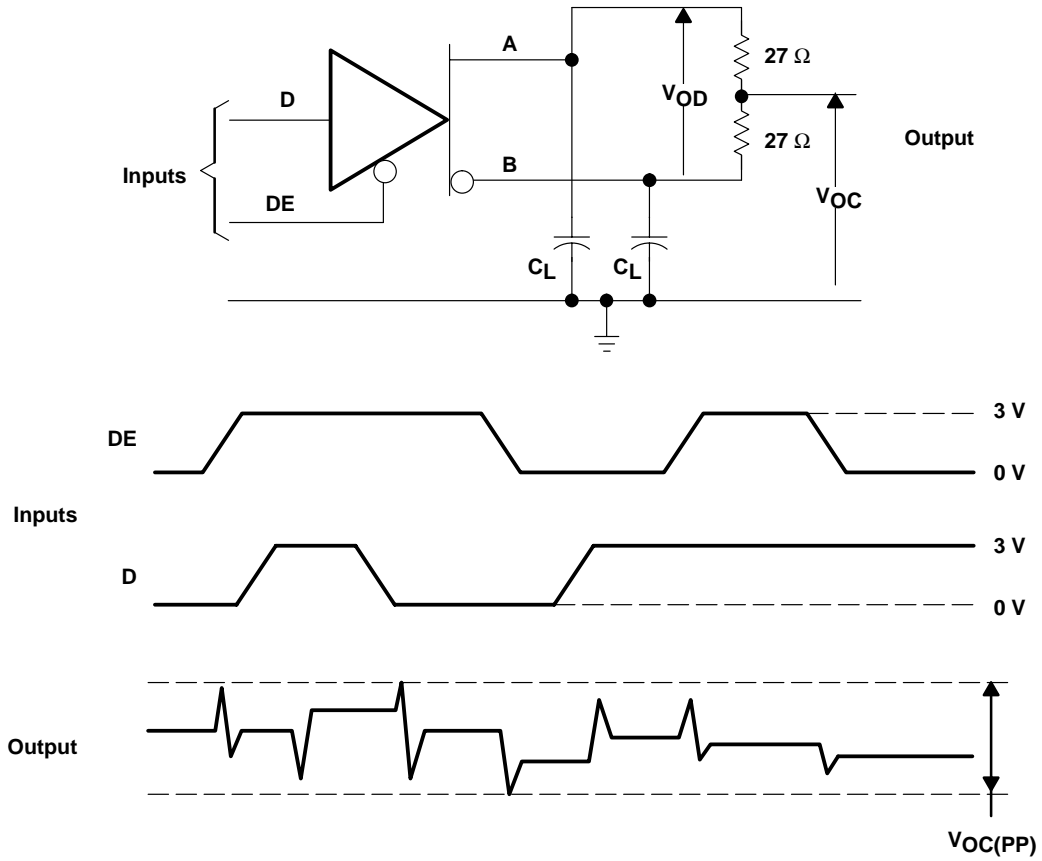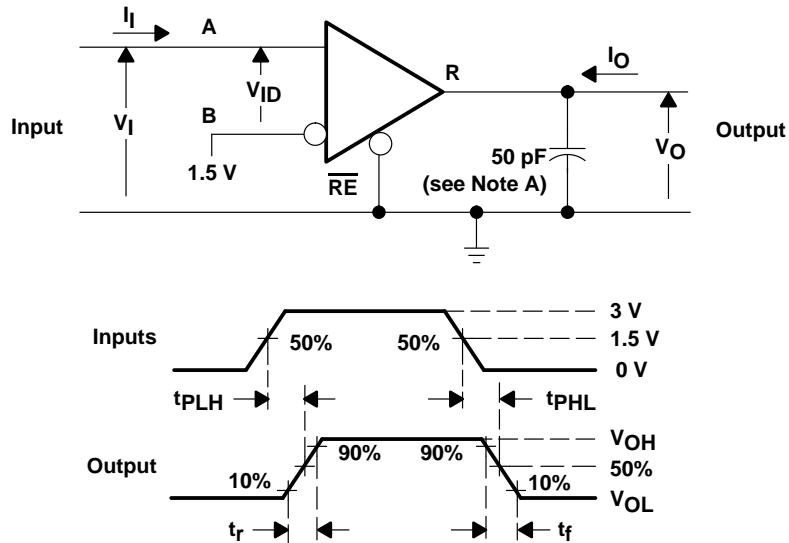
PARAMETER MEASUREMENT INFORMATION

Figure 5. Driver Timing, Voltage and Current Waveforms

PARAMETER MEASUREMENT INFORMATION

NOTES: A. Resistance values are in ohms and are 1% tolerance.
        B. C_L includes probe and jig capacitance ($\pm$ 10%).

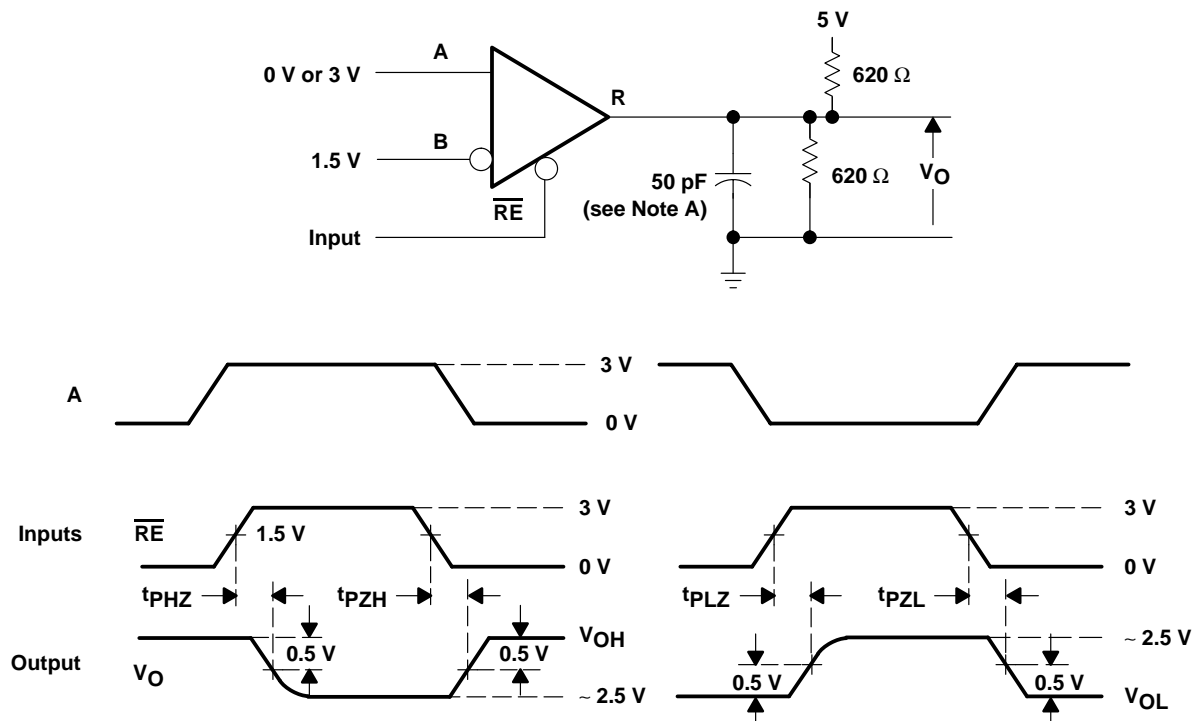**Figure 6. Driver $V_{OC(PP)}$ Test Circuit and Waveforms**

NOTE A: This value includes probe and jig capacitance ($\pm$ 10%).

Figure 7. Receiver t_{PLH} and t_{PHL} Test Circuit and Voltage Waveforms

PARAMETER MEASUREMENT INFORMATION

NOTE A: This value includes probe and jig capacitance (± 10%).

Figure 8. Receiver t_{PZL}, t_{PLZ}, t_{PZH}, and t_{PHZ} Test Circuit and Voltage Waveforms
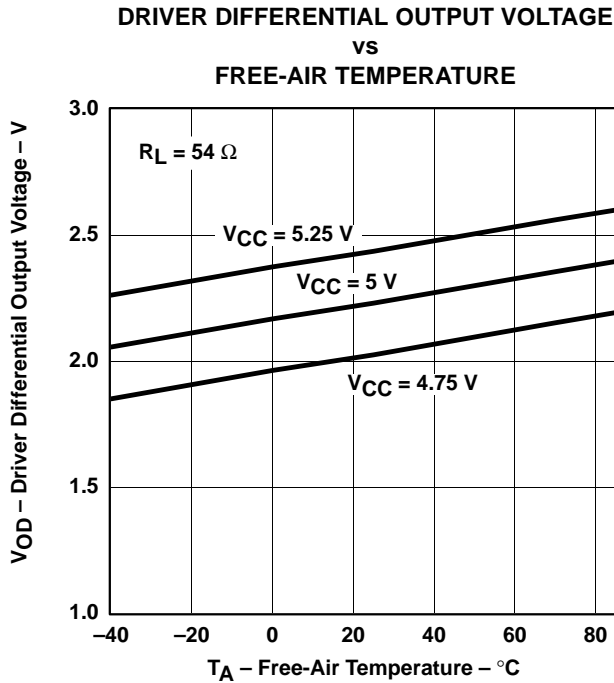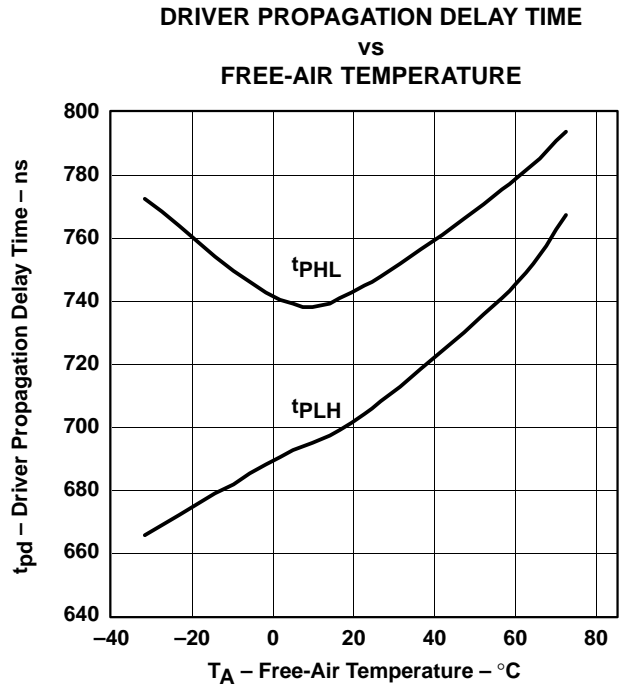
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TYPICAL CHARACTERISTICS

DRIVER DIFFERENTIAL OUTPUT VOLTAGE
vs
FREE-AIR TEMPERATURE

Figure 9

DRIVER PROPAGATION DELAY TIME
vs
FREE-AIR TEMPERATURE

Figure 10

DRIVER TRANSITION TIME
vs
FREE-AIR TEMPERATURE

Figure 11

DIFFERENTIAL OUTPUT VOLTAGE
vs
OUTPUT CURRENT

Figure 12

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11

TYPICAL CHARACTERISTICS

RECEIVER INPUT CURRENT
vs
INPUT VOLTAGE
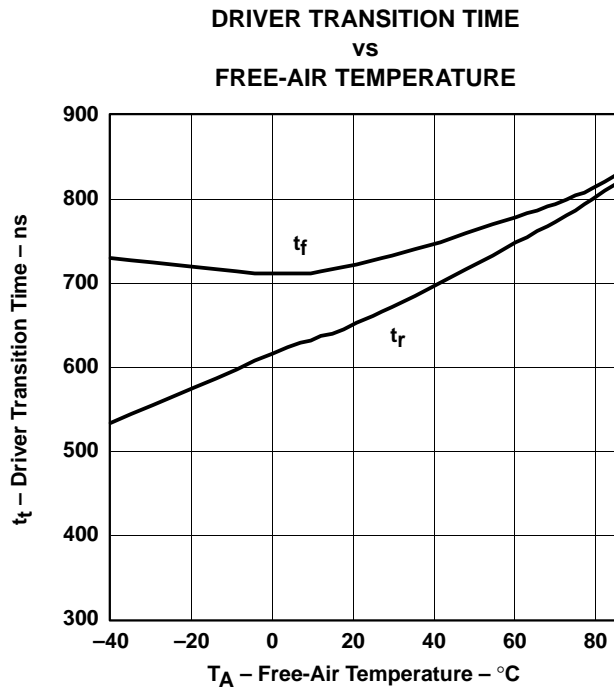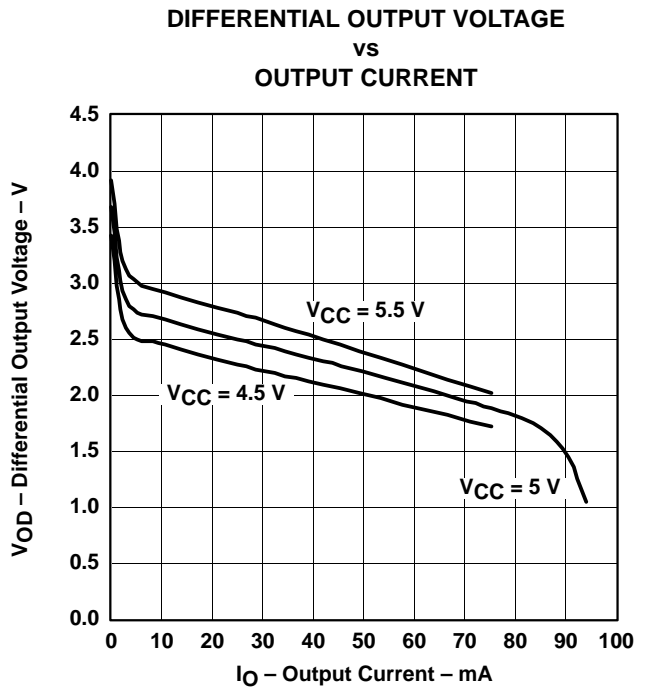
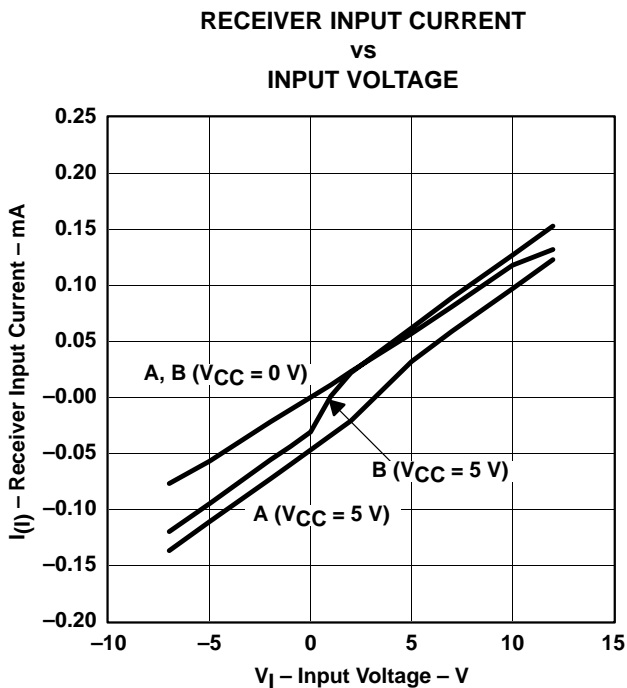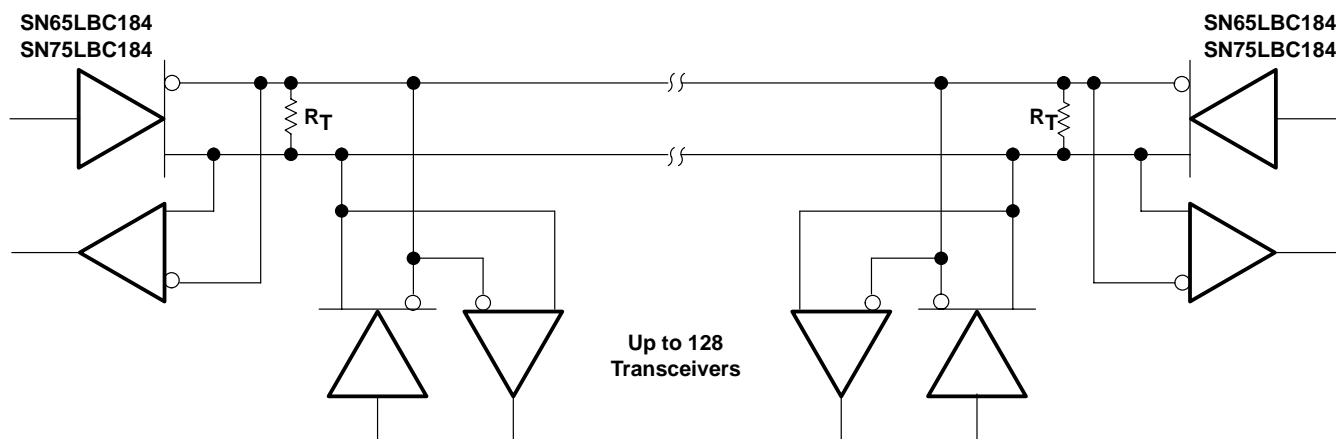**Figure 13**

APPLICATION INFORMATION

NOTE A: The line should be terminated at both ends in its characteristic impedance ($R_T = Z_O$). Stub lengths off the main line should be kept as short as possible.

Figure 14. Typical Application Circuit

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APPLICATION INFORMATION

'LBC184 test description

The 'LBC184 is tested against the IEC 61000–4–5 recommended transient identified as the combination wave. The combination wave provides a 1.2-/50-μs open-circuit voltage waveform and a 8-/20-μs short-circuit current waveform shown in Figure 15. The testing is performed with a combination/hybrid pulse generator with an effective output impedance of 2 Ω. The setup for the overvoltage stress is shown in Figure 16 with all testing performed with power applied to the 'LBC184 circuit.

NOTE
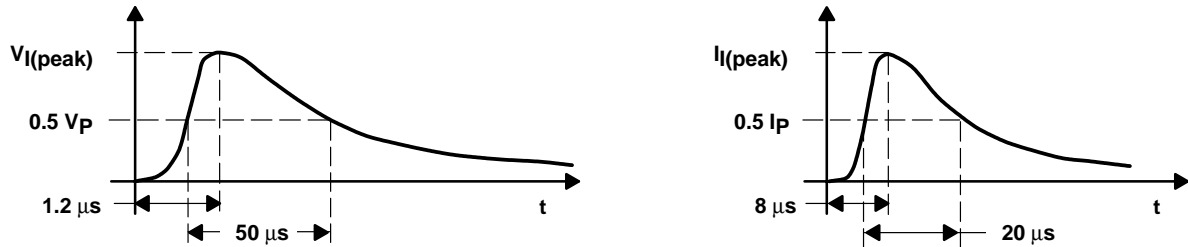High voltage transient testing is done on a sampling basis.

Figure 15. Short-Circuit Current Waveforms

The 'LBC184 is tested and evaluated for both maximum (single pulse) as well as life test (multiple pulse) capabilities. The 'LBC184 is evaluated against transients of both positive and negative polarity and all testing is performed with the worst-case transient polarity. Transient pulses are applied to the bus pins (A & B) across ground as shown in Figure 16.
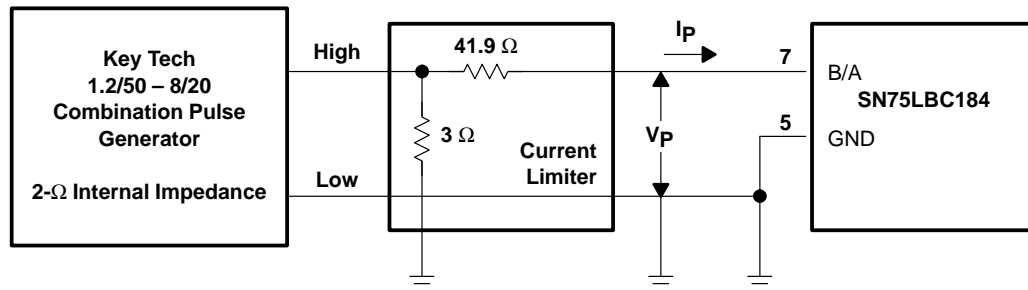
Figure 16. Overvoltage-Stress Test Circuit

An example waveform as seen by the 'LBC184 is shown in Figure 17. The bottom trace is current, the middle trace shows the clamping voltage of the device and the top trace is power as calculated from the voltage and current waveforms. This example shows a peak clamping voltage of 16 V, peak current of 33.6 A yielding an absorbed peak power of 538 W.

NOTE
A circuit reset may be required to ensure normal data communications following a transient noise pulse of greater than 250 W peak.

SN65LBC184, SN75LBC184
DIFFERENTIAL TRANSCEIVER
WITH TRANSIENT VOLTAGE SUPPRESSION
SLLS236E – OCTOBER 1996 – REVISED APRIL 2002

APPLICATION INFORMATION
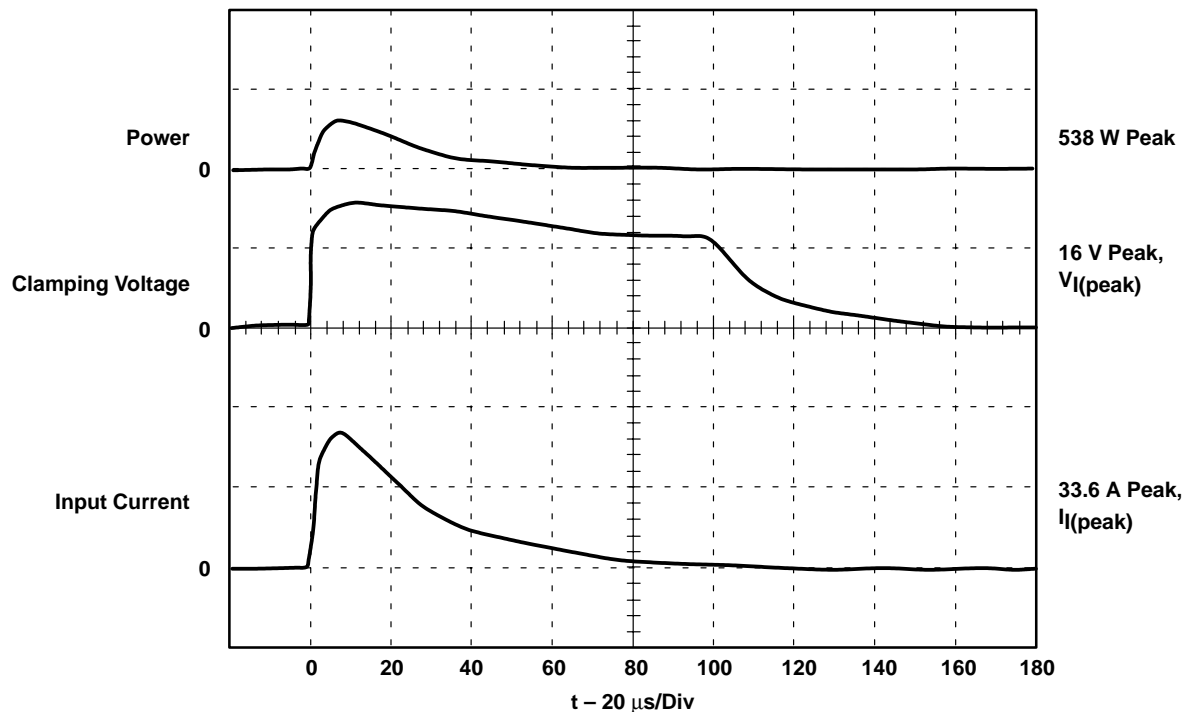
Figure 17. Typical Surge Waveform Measured At Terminals 5 and 7

MECHANICAL INFORMATION

D (R-PDSO-G**)   **PLASTIC SMALL-OUTLINE PACKAGE**

8 PINS SHOWN
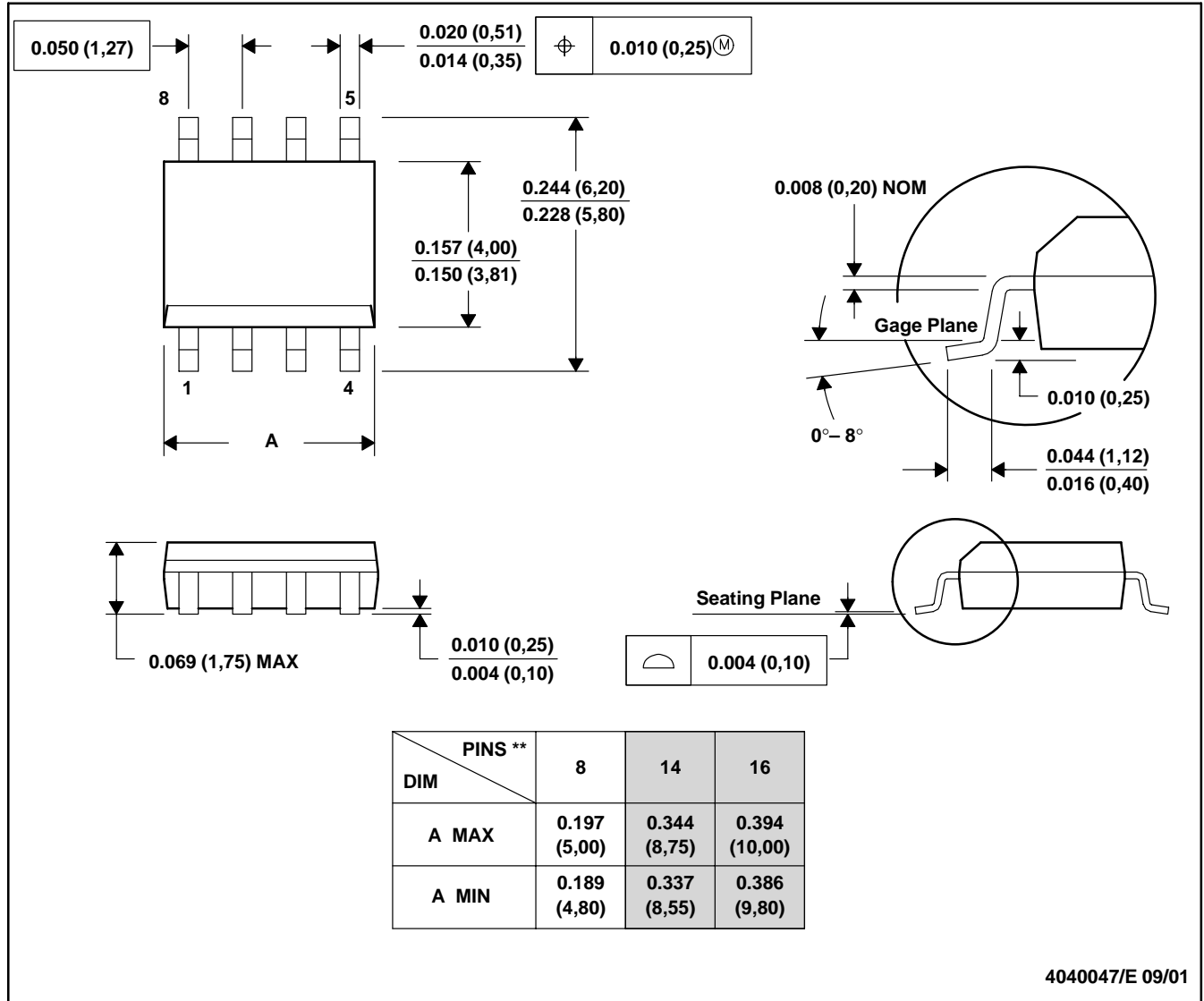
PINS ** DIM	8	14	16
A MAX	0.197 (5,00)	0.344 (8,75)	0.394 (10,00)
A MIN	0.189 (4,80)	0.337 (8,55)	0.386 (9,80)

4040047/E 09/01

NOTES: A. All linear dimensions are in inches (millimeters).
         B. This drawing is subject to change without notice.
         C. Body dimensions do not include mold flash or protrusion, not to exceed 0.006 (0,15).
         D. Falls within JEDEC MS-012

MECHANICAL INFORMATION

P (R-PDIP-T8)   **PLASTIC DUAL-IN-LINE**
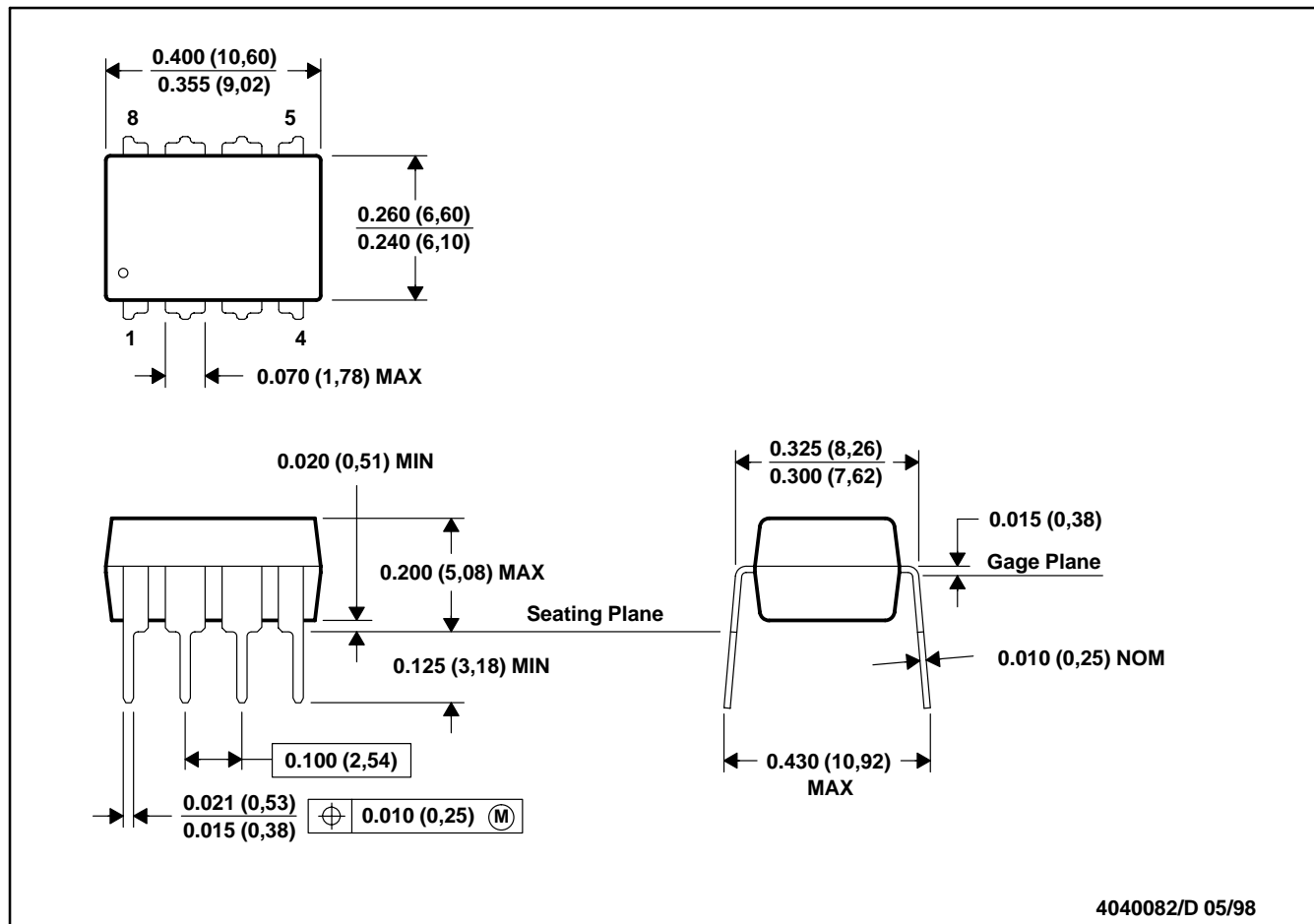
4040082/D 05/98

NOTES: A. All linear dimensions are in inches (millimeters).
           B. This drawing is subject to change without notice.
           C. Falls within JEDEC MS-001

For the latest package information, go to http://www.ti.com/sc/docs/package/pkg_info.htm

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PACKAGING INFORMATION

Orderable Device	Status [1]	Package Type	Package Drawing	Pins	Package Qty	Eco Plan [2]	Lead/Ball Finish	MSL Peak Temp [3]
SN65LBC184D	ACTIVE	SOIC	D	8	75	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1YEAR/ Level-1-220C-UNLIM
SN65LBC184DR	ACTIVE	SOIC	D	8	2500	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1YEAR/ Level-1-220C-UNLIM
SN65LBC184P	ACTIVE	PDIP	P	8	50	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
SN75LBC184D	ACTIVE	SOIC	D	8	75	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1YEAR/ Level-1-220C-UNLIM
SN75LBC184DR	ACTIVE	SOIC	D	8	2500	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1YEAR/ Level-1-220C-UNLIM
SN75LBC184P	ACTIVE	PDIP	P	8	50	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC

[1] The marketing status values are defined as follows:
ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.
PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.

[2] Eco Plan - May not be currently available - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.
None: Not yet available Lead (Pb-Free).
Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.
Green (RoHS & no Sb/Br): TI defines "Green" to mean "Pb-Free" and in addition, uses package materials that do not contain halogens, including bromine (Br) or antimony (Sb) above 0.1% of total product weight.

[3] MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDECindustry standard classifications, and peak solder temperature.

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